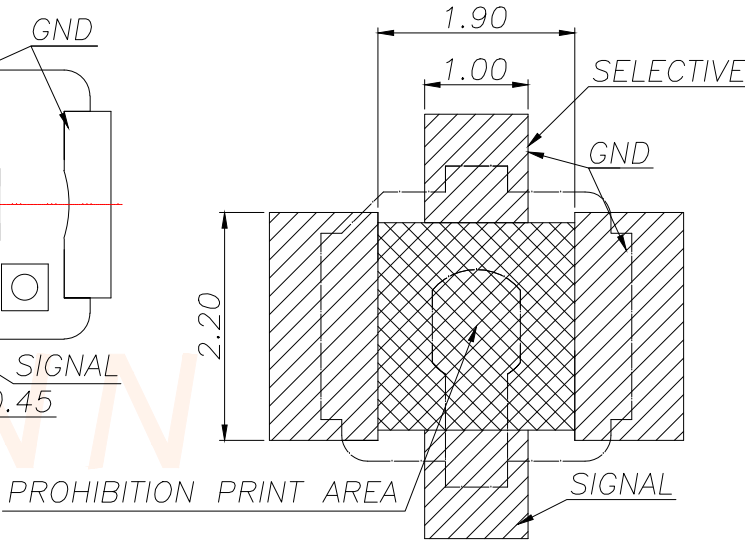


REV.	ECN NO.	DESCRIPTION	DATE	DESIGN

NOTES:
1.MATERIAL:
HOUSING--HIGH TEMP THERMAL PLASTIC,
UL 94V-0, NATURE;
TERMINAL--COPPER ALLOY;
SHELL--COPPER ALLOY;
2.PLATING:
TERMINAL--G/F PLATING ON CONTACT AREA
G/F PLATING ON SOLDERTAIL AREA
ALL OVER 1.27 MICRON MIN.
NICKEL PLATING;
SHELL--G/F PLATING OVER ALL;
3.PATENT PRODUCT PROHIBIT COPYING:

3SMT/4SMT PCBLAYOUT
FULLY COMPATIBLE



RECOMMEND PCB LAYOUT
TOLERANCE:±0.05MM

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
.X±0.38	±2°	PART NO. RF-IPEX-1	TITLE: RF CONN GEN I 4SMT TYPE		
.XX±0.20					
.XXX±0.10					
UNITS	mm	DESIGN:	Ethan	MANUFACTURE DWG	
MATERILA	---	CHED:	Olvia		SCALE
FINISH	---	APPD:	Ava		SHEET
				N:A	1/1